

## C0603X369D4HACTU

Aliases (C0603X369D4HAC7867)

SMD Comm X8R HT150C Flex, Ceramic, 3.6 pF, +/-0.5 pF, 16 VDC, X8R, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm



General Information			
Series	SMD Comm X8R HT150C Flex		
Style	SMD Chip		
Description	SMD, MLCC, High Temperature, Ultra-Stable		
Features	Ultra-Stable		
RoHS	Yes		
Termination	Flexible Termination		
Marking	No		
AEC-Q200	No		
Typical Component Weight	7.3 mg		
Shelf Life	78 Weeks		
MSL	1		

Dimensions		
Chip Size	0603	
L	1.6mm +/-0.17mm	
W	0.8mm +/-0.15mm	
Т	0.8mm +/-0.15mm	
S	0.4mm MIN	
В	0.45mm +/-0.15mm	
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	0.8mm +/-0.15mm		
S	0.4mm MIN		
В	0.45mm +/-0.15mm		
Packaging Specifications			
Packaging	T&R, 180mm, Paper Tape		

Packaging Quantity

4000

Specifications		
Capacitance	3.6 pF	
Measurement Condition	1 MHz 1.0Vrms	
Tolerance	+/-0.5 pF	
Voltage DC	16 VDC	
Dielectric Withstanding Voltage	40 VDC	
Temperature Range	-55/+150°C	
Temp. Coefficient	X8R	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1MegaHz 1.0Vrms	
Dissipation Factor	2.5% 1 MHz 1.0Vrms	
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance	100 GOhms	

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Insulation Resistance	100 GOhms

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